

AMPMODU | Micro Stack

TE Internal #: 6376608-1

PCB Mount Receptacle, Vertical, Board-to-Board, 80 Position, .6 mm [.023 in] Centerline, Gold, Surface Mount, Signal, Black, Micro

Stack

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Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 80

Centerline (Pitch): .6 mm [.023 in]

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	80
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Operating Voltage	10 VAC
Body Features	

Black

Primary Product Color



Contact Features

PCB Contact Termination Area Plating Material Thickness	.3 μm[31.5 μin]
PCB Contact Termination Area Plating Material	Gold Flash
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.3 μm
Contact Type	Socket
Contact Current Rating (Max)	.5 A

Termination Features

Rectangular Termination Post & Tail Thickness	.25 mm[.01 in]
Rectangular Termination Post & Tail Width	1 mm[.04 in]
Termination Method to Printed Circuit Board	Surface Mount

Mechanical Attachment

PCB Mount Alignment Type	Solder Peg
PCB Mount Retention Type	Solder Peg
Mating Alignment	With
Mating Alignment Type	Chamfered Edges
PCB Mount Retention	With
PCB Mount Alignment	With
Connector Mounting Type	Board Mount

Housing Features

Mating Entry Location	Тор
Centerline (Pitch)	.6 mm[.023 in]
Housing Material	LCP (Liquid Crystal Polymer)

Dimensions

Connector Height	13.6 mm[.53 in][.535 in]
PCB Thickness (Recommended)	1.6 mm

Usage Conditions

Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
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Operation/Application

Circuit Application	Signal	
	3.9	

Industry Standards



UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	45
Packaging Type	Tray

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts













Also in the Series | Micro Stack



Customers Also Bought















TE Part #172498-1 MIC PLUG HSG 13P (MK II)

Documents

Product Drawings
MICRO STACK REC ASSY 80P

English

CAD Files

3D PDF

3D



Customer View Model

ENG_CVM_CVM_6376608-1_L.2d_dxf.zip

English

Customer View Model

ENG_CVM_6376608-1_L.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_6376608-1_L.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Product Specification

Japanese

Product Environmental Compliance

MD_6376608-1_0714201488_dmtec

English

MD_6376608-1_0714201488_dmtec

English